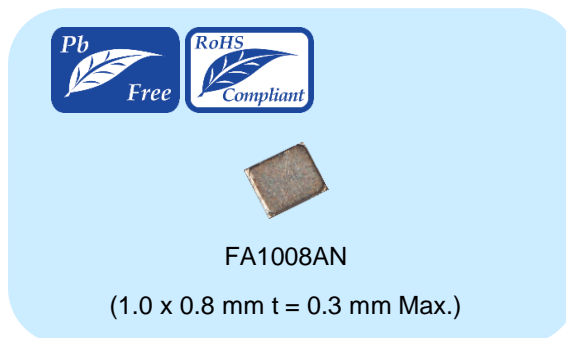


Tiny Size MHz range crystal unit:

Product Name: FA1008AN

Features

- Package size: 1.0 x 0.8 mm t = 0.3 mm Max.
- Frequency range: 40 MHz to 100 MHz
(Currently avail: 52 MHz, 59.97 MHz)
- Frequency tolerance: $\pm 10 \times 10^{-6}$ (+25 °C)
- Frequency vs. temperature characteristics:
 - $\pm 10 \times 10^{-6}$ (-20 to +75 °C)
 - $\pm 15 \times 10^{-6}$ (-30 to +85 °C)
 - $\pm 20 \times 10^{-6}$ (-40 to +85 °C)
 - $\pm 25 \times 10^{-6}$ (-40 to +105 °C)
- ESR: 60 Ω Max. (52 MHz, 59.97 MHz)



Applications

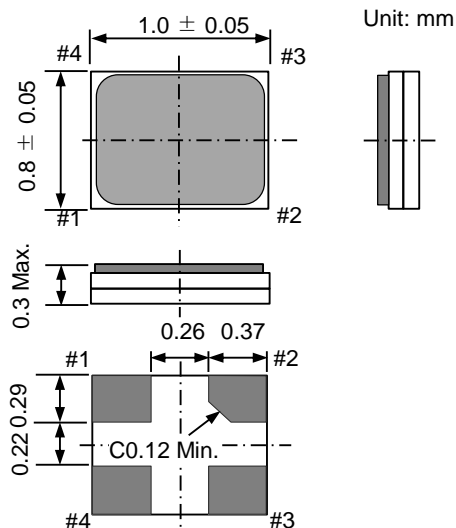
- Wearables, Smart speakers, Digital health
- Smartphone, Tablets, PCs
- General Consumer Electronics/Appliances
- Industrial IoT, Meter, Light/Building monitoring
- Enables wireless communication:
 - BLE, Wi-Fi, NB-IoT, etc.

Description

FA1008AN is tiny size enabling designers to save board space without compromising performance.

The wide MHz frequency up to 100MHz and operating temperature up to 105 °C serve the popular wireless communication protocols for consumer and industrial IoT applications, making the FA1008AN ideal for devices and modules pushing the limit on features and size.

Outline Drawing



Terminal Assignment

Pin	Connection
#1	X'tal
#2	GND
#3	X'tal
#4	GND

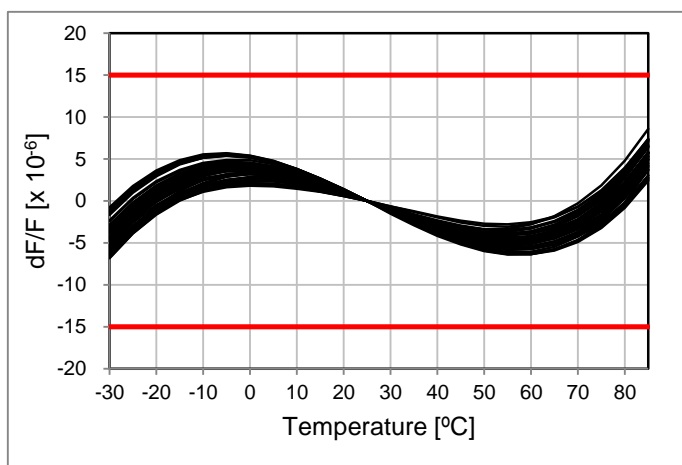
Internal connection
(TOP VIEW)



#2 and #4 are connected to the cover.
Please connect to ground

Typical Performance

Frequency vs. Temperature characteristics
(Frequency = 59.97MHz, n = 50)



[1] Product Number / Product Name

(1-1) Product Number

X1E000451xxxx26 (Please contact Epson for details)

(1-2) Product Name (Standard Form)

FA1008AN 59.970000MHz 12.0 +10.0-10.0

a b c d

a: Model b: Frequency c: Load capacitance (pF) d: Frequency tolerance ($\times 10^{-6}$, +25 °C)

In addition to the mentioned above specification items ("a" to "d"),
Please specify the frequency temperature characteristics from below Table1.

[2] Absolute Maximum Ratings

Item	Symbol	Rating value			Unit	Note
		Min.	Typ.	Max.		
Storage temperature range	T_stg	-40	-	+125	°C	Satisfy environmental characteristics specifications

[3] Operating Conditions

Item	Symbol	Rating value			Unit	Note
		Min.	Typ.	Max.		
Operating temperature range	T_use	-40	-	+105	°C	
Level of drive	DL	0.01	10	200	μW	Recommended: 10 μW

[4] Static Characteristics

Item	Symbol	Specifications			Unit	Conditions / Remarks
		Min.	Typ.	Max.		
Nominal frequency range	f_nom	40.000	-	100.000	MHz	Please contact Epson for frequencies other than those currently avail frequency Currently avail frequency
		52 / 59.97				
Frequency tolerance	f_tol	-10.0	-	+10.0	$\times 10^{-6}$	+25 °C \pm 3 °C DL = 10 μW Does not include frequency aging
Motional resistance (ESR)	R1	-	-	60	Ω	Currently avail frequency π circuit IEC 60444-2 T_use = -40 °C to +105 °C DL = 10 μW
Shunt capacitance	C0	-	-	1.0	pF	π circuit and Network Analyzer
Frequency vs. temperature characteristics	f_tem	Please specify from Table 1.			$\times 10^{-6}$	Reference at +25 °C \pm 3 °C
Load capacitance	CL	6	-	∞	pF	Please specify
Isolation resistance	IR	500	-	-	MΩ	
Frequency aging	f_age	-1.0	-	+1.0	$\times 10^{-6}$	Currently avail frequency +25°C , First year

Table 1. Frequency vs. temperature characteristics

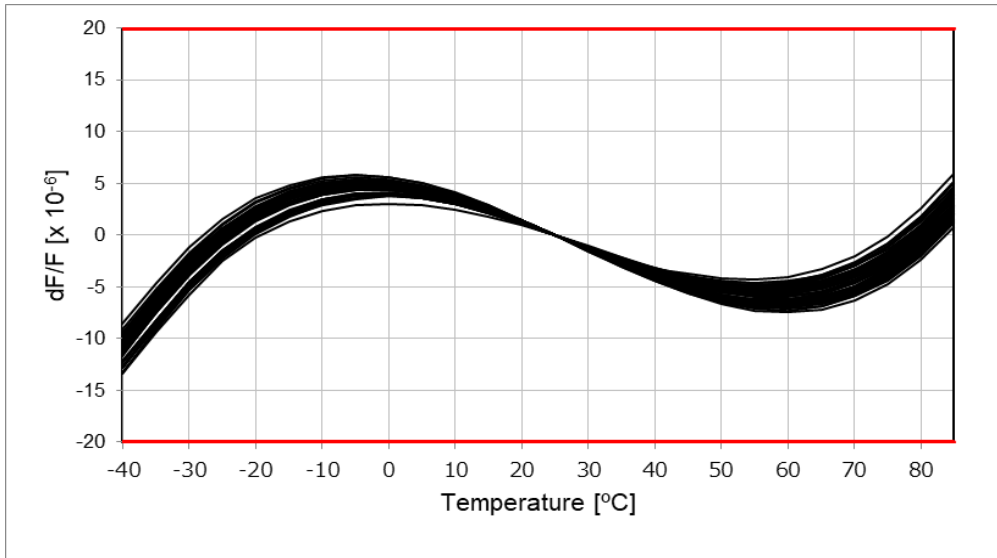
Operating temperature range	Frequency temperature characteristics
-20 °C to +75 °C	$\pm 10 \times 10^{-6}$
-30 °C to +85 °C	$\pm 15 \times 10^{-6}$
-40 °C to +85 °C	$\pm 20 \times 10^{-6}$
-40 °C to +105 °C	$\pm 25 \times 10^{-6}$

*Please contact Epson for other than the above

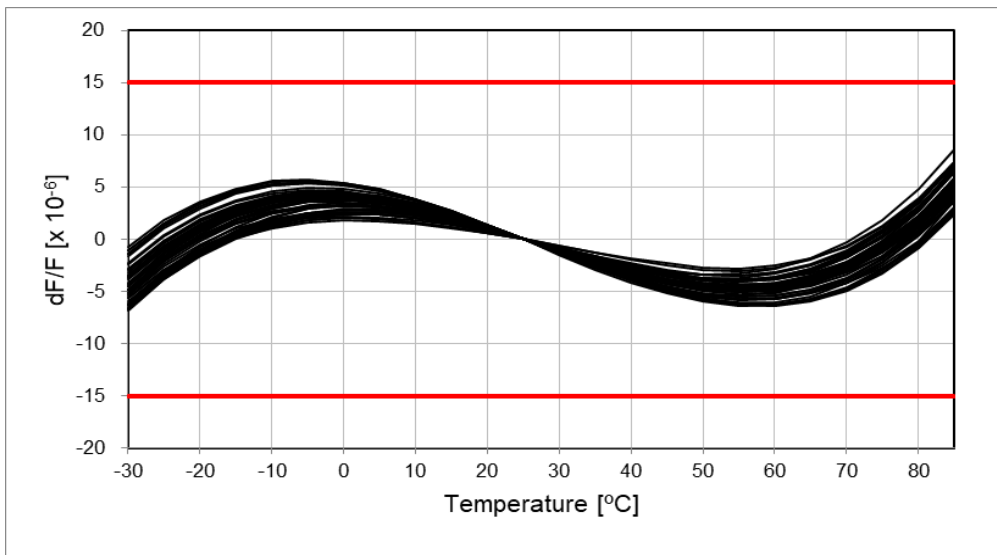
[5] Example of frequency vs. temperature characteristics

(5-1) 52 MHz: $\pm 20 \times 10^{-6}$ / -40°C to 85°C

n = 50

(5-2) 59.97 MHz: $\pm 15 \times 10^{-6}$ / -30°C to 85°C

n = 50



[6] Marking Description

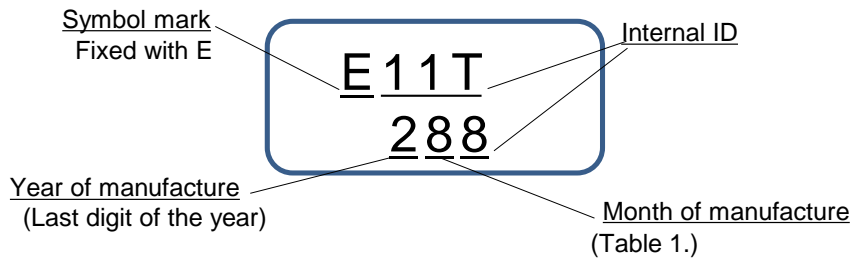
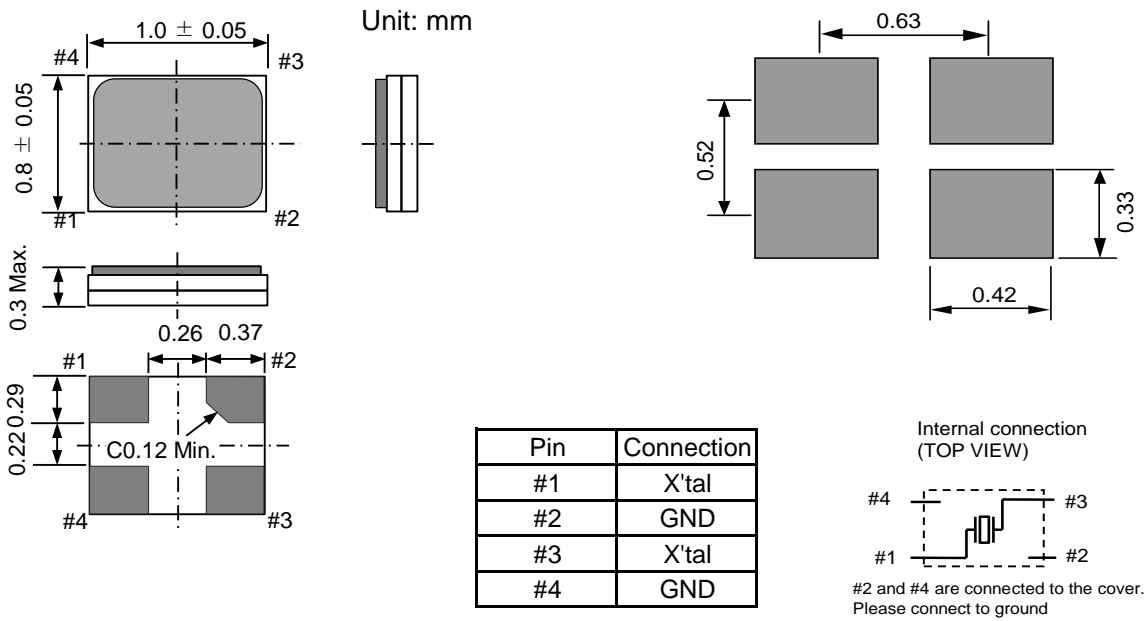


Table 1. Month of manufacture

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	X	Y	Z

[7] Outline Drawing and Recommended Footprint



Reference weight Typ.: 0.776 mg
Terminal coating: Au plating

[8] Moisture Sensitivity Level

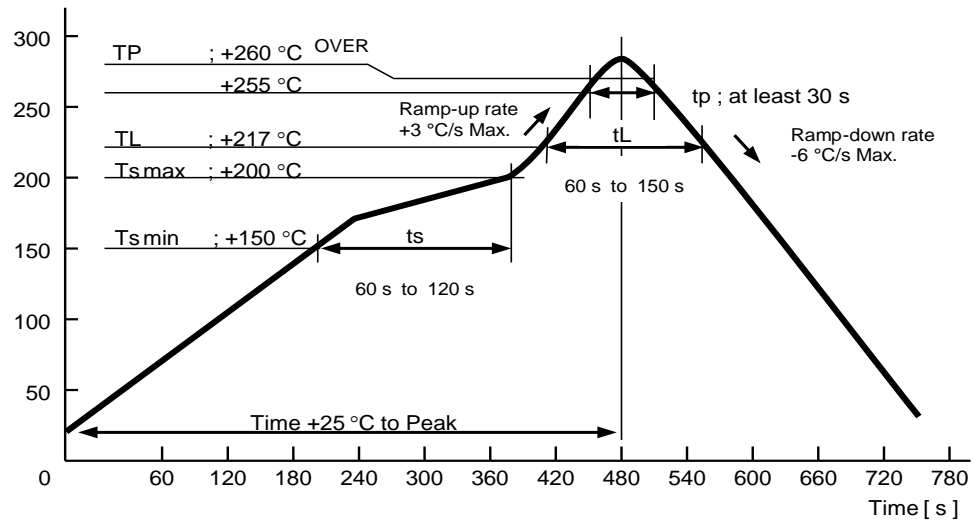
(8-1) Moisture Sensitivity Level (MSL)

Parameter	Specification	Conditions
MSL	LEVEL1	IPC/JEDEC J-STD-020E

[9] Reflow Profile

IPC/JEDEC J-STD-020E

Temperature [°C]



[11] Handling Precautions

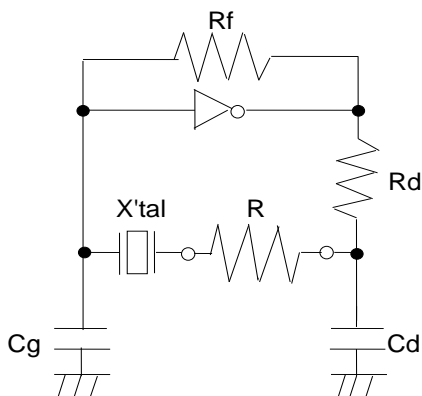
Prior to using this product, please carefully read the section entitled "Precautions" on our Web site (<https://www5.epsondevice.com/en/information/#precaution>) for instructions on how to handle and use the product properly to ensure optimal performance of the product in your equipment.

Before using the product under any conditions other than those specified therein, please consult with Epson to verify and confirm that the performance of the product will not be negatively affected by use under such conditions.

In addition to the foregoing precautions, in order to avoid degrading the performance of the product, we strongly advise that you adhere to the below recommendations:

1. Limit reflow to 3 times.
This product has gone through AuSn melt sealing.
Reflow mounting is recommended instead of using a soldering iron or air heater.
When the product is removed from a PCB board or module with a soldering iron, please do so carefully as excess heat to the AuSn sealing material (melt point +278 °C) may deteriorate the seal and hermeticity.
2. Avoid using the products if it received any excessive shocks and vibrations.
Crystal products may be damaged under some conditions during mounting if exposed to excess shock.
Please set the mounting conditions to a slow mounting speed on the PCB to minimize shock as much as possible.
Please review the conditions after the changed are made.
3. Keep the electrode wiring as short as possible to ensure normal oscillation.
4. Store the crystal products at normal temperature (+15 °C to +35 °C) and humidity (25 %RH to 85 %RH)
Storing the crystal products under higher temperature or high humidity over one year may affect frequency stability or solderability.
Contact Epson before use if the product has been stored outside the conditions mentioned above.
5. Ultrasonic equipment used for cleaning or bonding may deteriorate the characteristics of the product.
Be sure to check in advance.
6. In high humidity environment, dew condensation on the PCB board may cause malfunction such frequency shift or no oscillation.
7. Applying excessive drive level to the crystal units may cause deterioration of characteristics or damage.
Design and test the circuit so that the proper drive level is maintained.
8. The characteristic such as frequency, etc. may differ from your measurement depending on the measurement method or conditions.
Contact Epson for any questions.
9. Do not route any signal lines, supply voltage lines, or GND lines underneath the area where the oscillators are mounted.
If shielding with GND is required, shield the side furthest from the oscillator circuit.
any internal layers and on the opposite side of the PCB. care not to place signal lines near the product as this may have an adverse affect on the performance of the product.
10. Use soldering paste <80 μm Max, the products are low profile specification.
11. Ensure adequate negative resistance is allocated in the oscillation circuit,
otherwise oscillation startup time may increase or no oscillation may occur.
In order to avoid this, provide enough negative resistance that is 5 time the motional resistance(R1)
12. Aging specifications are estimated from environmental reliability tests and expected frequency variation over time.
They do not provide a guarantee of aging over the product lifecycle.
13. Should any customer use the product in any manner contrary to the precautions and/or advice herein,
such use shall be done at the customer's own risk.

< Check of Negative resistance >



1. Connect the resistance (R) to the circuit in series with the crystal unit.
2. Adjust (R) so that oscillation can start (or stop).
3. Measure (R) when oscillation just starts (or stops) in (2) above.
4. Recommended(R)
 $R > R1 \times 5$

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.



ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

■ Explanation of marks used in this datasheet

	<p>● Pb free.</p>
	<p>● Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive (Contains Pb in sealing glass, high melting temperature type solder or other)</p>

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